TOSHIBA BiCMOS Integrated Circuit Silicon Monolithic

TB9004FNG

5 V and 3.3/2.5/1.5 V Dual-Voltage Regulator with Watchdog Timer

The TB9004FNG is a system regulator IC for automotive applications, specially designed for 3.3/2.5/1.5V microcomputer systems. It incorporates two constant-voltage power outputs and various system reset functions.

One of the power outputs, V_{CC1} , supplies 3.4, 2.5, or 1.5 V, as selected according to the application. This output uses an external output transistor. Any desired current limiter value can be set using an external adjusting resistor.

The other power output, V_{CC2} , supplies 5.0 V and also uses an external output transistor. Any desired current limiter value can be set using an external adjusting resistor.

For a system reset, both power outputs have a low-voltage monitor, power-on reset, and watchdog timer.

With the both power outputs turned off, the TB9004FNG consumes 0 $\mu A.$

Features

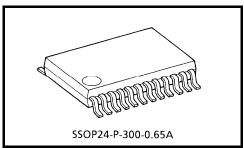
- Power output VCC1
 - Output voltage: 3.4 V \pm 0.10 V/2.55 V \pm 0.10 V/1.55 V \pm 0.07 V (selectable)
 - Output current: 600 mA (with external transistor)
 - Current limiter: Variable using external adjusting resistor
- Power output VCC2
 - Output voltage: $5.0 \text{ V} \pm 0.12 \text{ V}$
 - Output current: 600 mA (with external transistor)
 - Current limiter: Variable using external adjusting resistor
- Reset functions: Low-voltage monitor, power-on reset, and watchdog timer
- Low current consumption: Active (V_{CC1}/V_{CC2} = ON): 300 µA (typ.)

Standby (V_{CC1} = ON, V_{CC2} = OFF): 150 μ A (typ.) Stop (V_{CC1}/V_{CC2} = OFF): 0 μ A (typ.)

- W/D stop control: Control start/stop of watchdog timer
- Operating temperature range: -40 to 125°C
- Small flat package: 24-pin SSOP (0.65-mm pitch)
- The product(s) is/are compatible with RoHS regulations (EU directive 2002 / 95 / EC) as indicated, if any, on the packaging label ("[[G]]/RoHS COMPATIBLE", "[[G]]/RoHS [[Chemical symbol(s) of controlled substance(s)]]", "RoHS COMPATIBLE" or "RoHS COMPATIBLE, [[Chemical symbol(s) of controlled substance(s)]]>MCV").

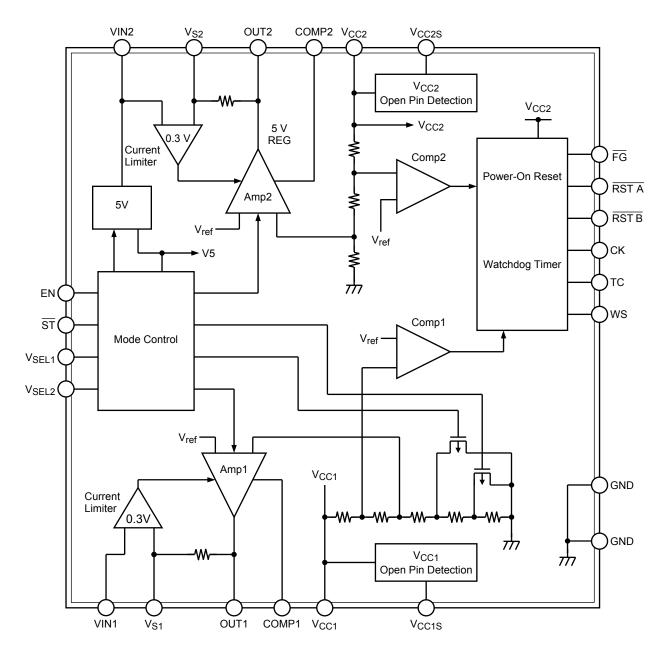
About Solderability, following conditions were confirmed

- Solderability
 - (1) Use of Sn-37Pb solder Bath
 - solder bath temperature = 230°C
 - dipping time = 5 seconds
 - the number of times = once
 - use of R-type flux
 - (2) Use of Sn-3.0Ag-0.5Cu $\,$ solder Bath
 - solder bath temperature = 245°C
 - dipping time = 5 seconds
 - the number of times = once
 - use of R-type flux



Weight: 0.14 g (typ.)

Block Diagram

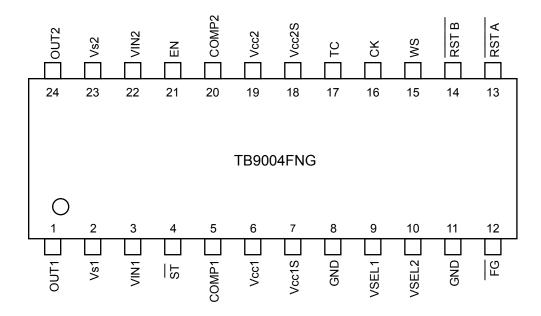


Note: The block diagram may show some of the functional blocks, circuits, or constants in abbreviated or simplified format for clarity in describing the relevant features.

TB9004FNG

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Pin Layout

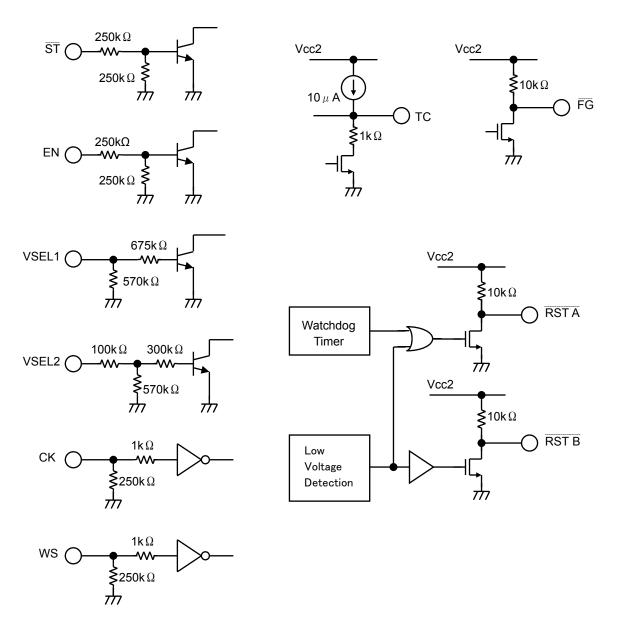


Pin Description

Pin No.	Symbol	Description
1	OUT1	External transistor control pin. Connect the base of the external PNP transistor to this pin.
2	V _{S1}	Detection pin for the V_{CC1} current limiter. A voltage drop occurring in the external resistor Rs1 between VIN1 and VS1 is monitored. The current limiter is actuated when the voltage drop exceeds 0.3 V.
3	V _{IN1}	Power supply input pin for V _{CC1} .
4	ST	Enable pin for ON/OFF control of the V _{CC1} /V _{CC2} constant-voltage power outputs. Driving ST high turns the outputs on while driving it low turns them off. When both outputs are turned off, the TB9004FNG consumes a current of 0 μ A (typ.). It contains a 250 k Ω pull-down resistor.
5	COMP1	Phase compensating pin for $V_{CC1}.$ Connect a phase compensating capacitor between V_{CC1} and this pin.
6	V _{CC1}	Voltage detection output pin for V _{CC1} . Connect the collector of the external PNP transistor to this pin. This pin provides a 3.3, 2.5, or 1.5 V constant-voltage feedback.
7	V _{CC1S}	Pin for detecting whether the V _{CC1} pin is open. If there is a voltage difference between V _{CC1} and V _{CC1S} , the TB9004FNG lowers the V _{CC1} output voltage.
8	GND	Ground pin
9	V _{SEL1}	Pin for selecting the V _{CC1} output voltage from among 3.3, 2.5, and 1.5 V. The voltage is selected using a combination of V _{SEL1} and V _{SEL2} . This pin incorporates a
10	V _{SEL2}	pull-down resistor.
11	GND	Ground pin
12	FG	Flag output when V _{CC1} or V _{CC2} is detected to be open. The pin is usually high but driven low when either pin is detected to be open. N-ch MOS drain output with a 10 k Ω pull-up resistor connected to V _{CC2} .
13	RST A	$\label{eq:V_CC1} V_{CC2} \mbox{ low-voltage monitor output and power-on reset/watchdog timer reset output pin} \\ \cdot \mbox{ Generates a reset signal when a low voltage is detected for } V_{CC1} \mbox{ or } V_{CC2}. \\ \cdot \mbox{ Generates a reset signal which is determined by the capacitor CT connected to the TC pin.} \\ \cdot \mbox{ Intermittently generates reset pulses if no clock is supplied to the CK pin.} \\ N-ch MOS drain output with a 10 k\Omega pull-up resistor connected to V_{CC2}. \\ \end{array}$
14	RST B	Low-voltage monitor output pin for V _{CC1} and V _{CC2} . Generates a reset signal when a low voltage is detected for V _{CC1} or V _{CC2} . Linked with a power-on reset but not linked with the watchdog timer.
15	WS	Enable pin for ON/OFF control of the watchdog timer. Driving WS low turns the timer on while driving it high turns the timer off. Use this pin when the watchdog timer is not necessary or to stop it temporarily. It contains a 250 k Ω pull-down resistor to GND.
16	СК	Clock input pin for the watchdog timer. It contains a 250 k Ω pull-down resistor connected to GND.
17	тс	Pin for setting a time for the power-on reset timer and watchdog timer when V _{CC1} and V _{CC2} rise. It connects to a capacitor CT which is grounded. It contains a 10 μ A pull-up constant current.
18	V _{CC2S}	Pin for detecting whether the V _{CC2} pin is open. If there is a voltage difference between V _{CC2} and V _{CC2S} , the TB9004FNG lowers the V _{CC2} output voltage.
19	V _{CC2}	Voltage detection pin for the 5 V constant-voltage power supply, V_{CC2} . It also supplies power to the reset timer block.
20	COMP2	Phase compensating pin for $V_{CC2}.$ Connect a phase compensating capacitor between V_{CC2} and this pin.
21	EN	Enable pin for ON/OFF control of the V _{CC2} constant-voltage power output. Driving EN high turns the 5 V output on while driving it low turns the output off. It contains a 250 k Ω pull-down resistor.
22	V _{IN2}	Power supply input pin.
23	V _{S2}	Detection pin for the V _{CC2} current limiter. A voltage drop occurring in the external resistor Rs2 between V _{IN2} and V _{S2} is monitored. The current limiter is actuated when the voltage drop exceeds 0.3 V.
24	OUT2	External transistor control pin. Connect the base of the external PNP transistor to this pin.

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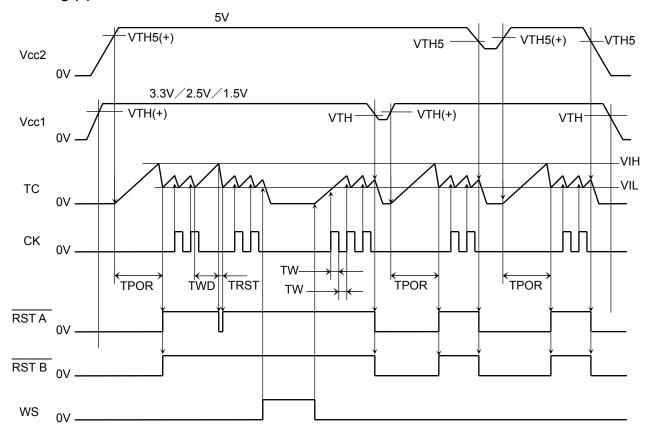
Internal Circuits of Input/Output Pins



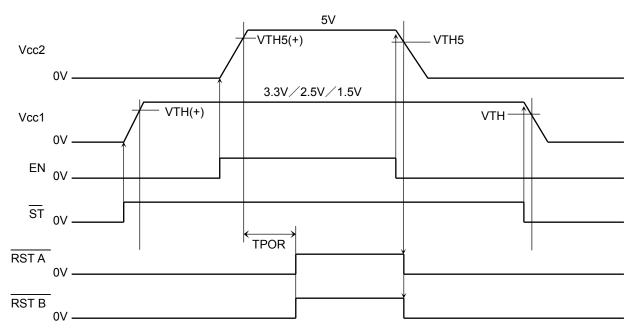
Note: The internal circuit diagrams are intended as an aid for describing circuits; they may be shown in abbreviated or simplified format.

Timing Charts





Timing (2)



Note1: See Electrical Characteristics about symbols in timing charts.

Note2: Timing charts may be simplified to clarify the descriptions of features and operations.

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Pins	Rating	Unit	
	VIN-1	VIN1,VIN2	45 (1 s)		
Input voltage	VIN-2	EN,ST, VSEL1,VSEL2	VIN2	V	
	VIN-3	CK,TC,WS	Vcc2		
	VIN-4	VIN1, VIN2	40		
Output current	IOUT1	RST A,RST B	10	mA	
Output current	IOUT2	FG	10	mA	
Operating temperature	T _{opr}	-	-40 to 125	°C	
Storage temperature	T _{stg}	_	-55 to 150	°C	

Note: The absolute maximum ratings of a semiconductor device are a set of specified parameter values that must not be exceeded during operation, even for an instant.

If any of these levels is exceeded during operation, the electrical characteristics may be irreparably altered and the reliability and lifetime of the device can no longer be guaranteed, possibly causing damage to any other equipment with which it is used. Applications using the device should be designed so that the absolute maximum ratings will never be exceeded in any operating conditions.

Ensuring that the parameter values remain within these specified ranges during device operation will help to ensure that the integrity of the device is not compromised.

Electrical Characteristics (unless otherwise specified, VIN = 6 to 16 V, I_{LOAD} -1 = 10 mA, I_{LOAD} -2 = 10 mA, Ta = -40 to 125°C)

Characteristics	Symbol	Applicable Pins	Test Conditions	Min	Тур.	Max	Unit
DC characteristics							
Supply current	ICC		$\overline{ST} = EN = H$	-	300	500	
Standby current	I _{CC} -stb	VIN1 + VIN2	$\overline{ST} = H, EN = L$	-	150	250	μA
Stop current	I _{CC} -off		ST = L	-	0	10	
Regulator							
	V _{REG3.3}	V _{CC1}	V _{SEL1} = H, V _{SEL2} = H	3.3	3.4	3.5	
Output voltage	V _{REG2.5}	V _{CC1}	$V_{SEL1} = H, V_{SEL2} = L$	2.45	2.55	2.65	V
Oulput voltage	V _{REG1.5}	V _{CC1}	V _{SEL1} = L, V _{SEL2} = L	1.48	1.55	1.62	v
	V _{REG5.0}	V _{CC2}	-	4.88	5.0	5.12	
Output current	IOUT	OUT1, OUT2	_	10	-	-	mA
	VLINE1(1)	V _{CC1}	VIN1 = 6 to 40 V	-	0.1	0.5	%
Line regulation	VLINE2(1)	V _{CC2}	VIN2 = 6 to 40 V	-	0.1	0.5	
	VLINE1 (2)	V _{CC1}	VIN1 = 4 to 5.15 V	-	0.02	0.1	
Load regulation	V _{LOAD1}	V _{CC1}	I _{LOAD} = 1 to 200 mA	-	0.2	1.0	%
Load regulation	V _{LOAD2}	V _{CC2}	I _{LOAD} = 1 to 300 mA	-	0.2	1.0	
Temperature coefficient	-	V _{CC1} , V _{CC2}	_	-	0.01	-	%/°C
Current limiter detection	VLIMIT	Vcc1-Vs1, Vcc2-Vs2	_	0.225	0.300	0.375	V
Mode Select			I				
Input current	lin		VIN (ST) = 14 V	25	50	100	μA
la su de su la su	VIH	ST	_	2	-	-	
Input voltage	VIL		_	-	-	0.5	V
Input current	lin		VIN (EN) = 14 V	25	50	100	μA
Input voltage	VIH	EN	_	2	-	-	V
Input voltage	VIL		_	-	-	0.5	V
Input current	IIN		VIN (V _{SEL}) = 3.4 V	5	10	20	μA
	VIH	VSEL1 VSEL2	_	1.0	-	_	V
Input voltage	VIL		-	-	-	0.3	v
Input voltage difference	∆VTH-SEL	VSEL1 VSEL2	VTH(VSEL2) – VTH(VSEL1)	0.05	0.1	0.15	V

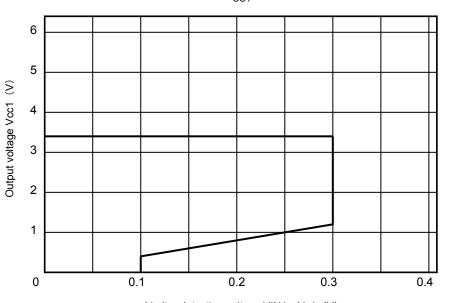
Note: The specification value for supply current is the value measured when $I_{LOAD} = 0$ mA.

Electrical Characteristics (unless otherwise specified, VIN = 6 to 18 V, I_{LOAD} -1 = 10 mA, I_{LOAD} -2 = 10 mA, Ta = 40 to 125°C)

							-
Characteristics	Symbol	Applicable Pins	Test Conditions	Min	Тур.	Max	Unit
Reset timer DC characteristics	;	•	•				
Output voltage	VOL		IOL = 2 mA	-	_	0.3	V
Output leakage current	ILEAK	RST A, RST B	V IN(RST) = V _{CC2}	-	-	5	μA
Output voltage	VOL	FG	IOL= 2 mA	-	-	0.3	V
Output leakage current	ILEAK	FG	VIN(FG)=Vcc2	-	-	5	μA
Input current	IIN	тс	-	-13	-10	-7	μA
Thrashold voltage	VIH	тс	-	3.75	4	4.25	v
Threshold voltage	VIL		-	1.8	2	2.2	v
Input ourropt	IIH	СК	V _{IN (CK)} = 5 V	10	20	40	μA
Input current	IIL		V _{IN (CK)} = 0 V	-	-	10	μΑ
Input voltage	VIH	ск	-	$0.8 \times V_{CC2}$	-	-	v
input voitage	VIL	ÖK	-	-	_	$0.2 \times V_{CC2}$	
Input current	IIH	ws	VIN (WS) = 5 V	10	20	40	μA
Input current	IIL		V IN (WS)= 0 V	-	-	10	
	VIH	- WS	-	$\begin{array}{c} 0.8 \times \\ V_{CC2} \end{array}$	-	-	- V
Input voltage	VIL		_	_	-	0.2× V _{CC2}	
	VTH3.3	V _{CC1}	VREG3.3	3.0	3.15	3.3	v v v
	ΔVTH3.3		VREG3.3-VTH3.3	0.20	0.25	0.30	
	Vhys3.3		VTH3.3(+)-VTH3.3		0.05	-	
	VTH2.5		VREG2.5	2.3	2.4	2.5	
	ΔVTH2.5	V _{CC1}	VREG2.5-VTH2.5	0.10	0.15	0.20	
Reset threshold voltage	Vhys2.5		VTH2.5(+)-VTH2.5	-	0.04	-	
	VTH1.5		VREG1.5	1.35	1.41	1.47	
	ΔVTH1.5	V _{CC1}	VREG1.5-VTH1.5	0.10	0.14	0.18	
	Vhys1.5		VTH1.5(+)-VTH1.5	-	0.03	-	
	VTH5		-	4.5	4.7	4.9	
	ΔVTH5	V _{CC2}	VREG5.0-VTH5	0.25	0.30	0.35	
	Vhys5		VTH5(+)—VTH5	-	0.10	-	
"L" Hold voltage of reset output	VRLo	V _{CC2}	*see note3	-	_	1.5	V
Reset timer AC characteristics	;		1		1	1	
Power-on reset	TPOR	RST A , RST B	-	280 × CT	400 × CT	520 × CT	ms
Watchdog timer	TWD	RST A	-	140 × CT	200 × CT	260 × CT	ms
Reset timer	TRST	NOTA	_	0.3 × CT	0.7 × CT	1.5 × CT	1115
Clock pulse width	TW	СК	-	3	_	_	μS

- Note 1: The units for CT are μ F.
- Note 2: The specification values for power-on reset, watchdog timer and reset timer above are intended to guarantee only for this IC. Note that the fluctuations of the CT value should be taken into consideration for practical use of the IC.
- Note 3: VCC2 threshold voltage which \overrightarrow{RSTA} or \overrightarrow{RSTB} can output "L"-level when V_{CC2} level rises or falls.

Reference Characteristics



Current limiter detection voltage characteristics $$V_{\text{CC1}}$$



Current limiter detection voltage characteristics

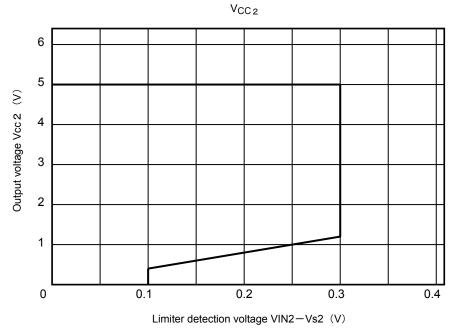


Table of Truth Value(1)

	Inp	out	Ou	Mode			
ST	EN	VSEL1	VSEL2	V _{CC1}	V _{CC2}	wode	
н	Н	L	L	1.5 V	5 V		
н	Н	Н	L	2.5 V	5 V	Active	
н	Н	Н	Н	3.4 V	5 V		
н	L	L	L	1.5 V	0 V (OFF)		
н	L	Н	L	2.5 V	0 V (OFF)	Standby	
н	L	Н	Н	3.4 V	0 V (OFF)		
L	Don't Care	Don't Care	Don't Care	0 V (OFF)	0 V (OFF)	Stop	

Table of Truth Value(2) (V_{CC1} states during normal operation and when V_{SEL1/2} is open)

	Normal Operation		Pin is Open		
VSEL1	VSEL2	V _{CC1}	Open Pin	V _{CC1}	
1	L	1.5 V	VSEL1	1.5 V	
L			VSEL2	1.5 V	
Н	L	2.5 V	VSEL1	1.5 V	
11			VSEL2	2.5 V	
н	н	3.4 V	VSEL1	1.5 V	
			VSEL2	2.5 V	

Test Mode

Driving VSEL1 low and VSEL2 high causes the TB9004FNG to enter test mode for evaluating and inspecting the IC.

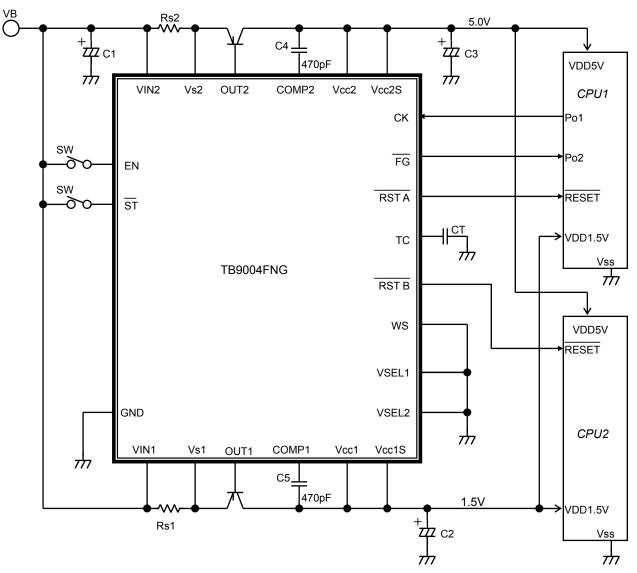
This function must not be used in an actual application.

The input V_{TH} for VSEL1 is 0.1 V (typ.) lower than that for VSEL2. The difference is specified as Δ VTH-SEL in the electrical characteristics. If voltage is applied with VSEL1 and VSEL2 short-circuited, the VSEL1/2 states can only become L/L, H/L or H/H, thus preventing the IC from entering test mode. When set VSEL1 or VSEL2 to L, please connect to GND.

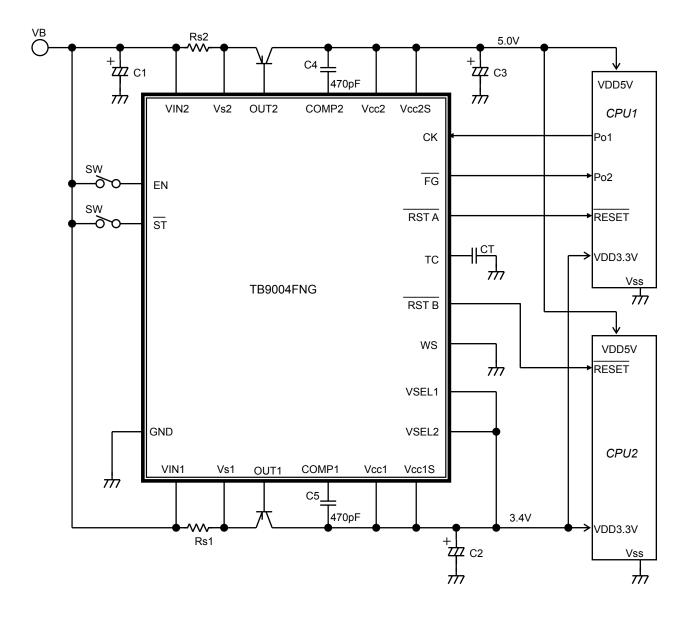
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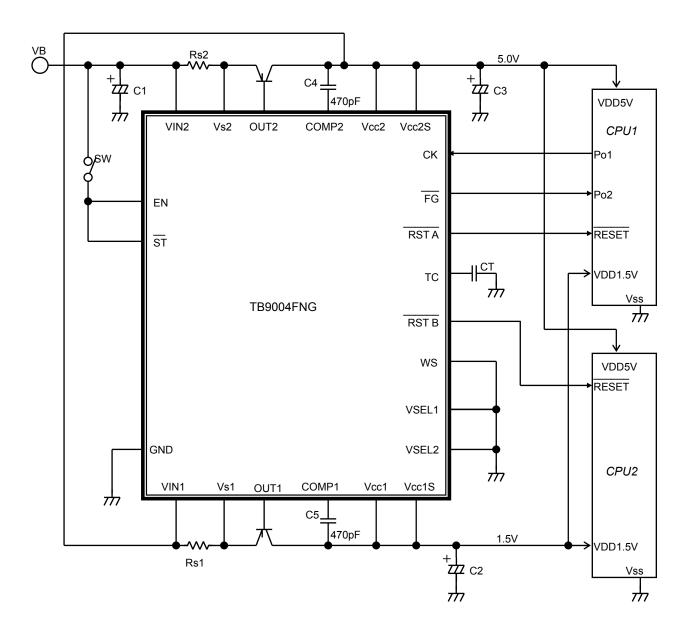
Examples of Application Circuit

Example (1) 5V/1.5 V constant-voltage output power supply, 5V/1.5 V parallel connection.



Example (2) 5V/3.4 V constant-voltage output power supply, 5V/3.4 V parallel connection.





Example (3) 5V/1.5 V constant-voltage output power supply, 5V/1.5 V series connection.

Note 1: Caution for wiring

C1, C2 and C3 are capacitors for absorbing disturbance noise, etc. Connect them as close to the IC as possible. C4 and C5 are capacitors for phase compensation. Connect them as close to the IC as possible.

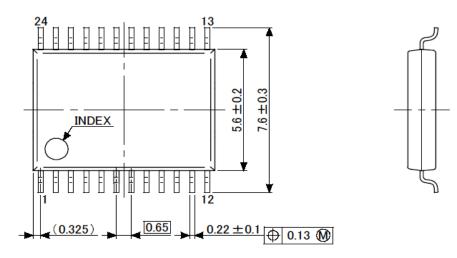
- Note 2: Ensure that the IC is mounted correctly as specified. Failing to observe the correct mounting procedure or requirements may result in the IC or target equipment being damaged.
- Note 3: The example application circuit is not guaranteed for mass production. Additional thorough evaluation is required if the device is used in an application intended for mass production.

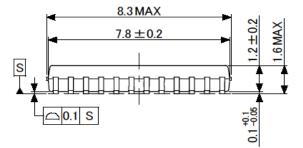
Recommended Conditions

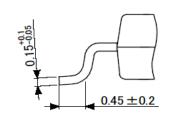
Part Name	Min	Max	Unit	
СТ	0.01	10	μF	

TB9004FNG

SSOP24-P-300-0.65A







Weight: 0.14 g (typ.)

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